

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lay bed ON Semiconductor and its officers, employees, ween if such claim alleges that ON Semiconductor was negligent regarding the d

March 2006

FDS9934C Complementary

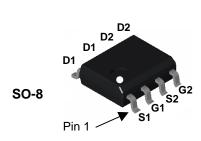
FAIRCHILD SEMICONDUCTOR®

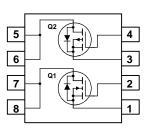
These dual N- and P-Channel enhancement mode power field effect transistors are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state ressitance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- Q1: 6.5 A, 20 V. $R_{DS(ON)} = 30 \ m\Omega @ V_{GS} = 4.5 \ V$ $R_{DS(ON)} = 43 \ m\Omega @ V_{GS} = 2.5 \ V.$
- Q2: -5 A, -20 V, $R_{DS(ON)}$ = 55 m Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 90 m Ω @ V_{GS} = -2.5 V





Absolute Maximum Ratings T_A=25°C unless otherwise noted Symbol Parameter Ratings

Symbol	Parameter		Ratings		Units	
			Q1	Q2		
V _{DSS}	Drain-Source Voltage		20	-20	V	
V _{GSS}	Gate-Source Voltage		±10	±12	V	
I _D	Drain Current – Continuous (Note 1a)		6.5	-5	А	
	– Pulsed		20	-30		
P _D	Power Dissipation for Dual Operation		2		W	
	Power Dissipation for Single Operation	(Note 1a)	1.6			
		(Note 1b)				
		(Note 1c)	0	.9		
T _J , T _{STG}	Operating and Storage Junction Temperature Range -55 to +150 °C				°C	
Thermal C	haracteristics					
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	Thermal Resistance, Junction-to-Ambient (Note 1a) 78		°C/W		
R _{θJC}	Thermal Resistance, Junction-to-Case (Note 1) 40		°C/W			

Device Marking	Device	Reel Size	Tape width	Quantity
FDS9934C	FDS9934C	13"	12mm	2500 units

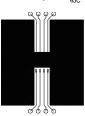
©2006 Fairchild Semiconductor Corporation

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Cha	racteristics						
BV _{DSS}	Drain-Source Breakdown Voltage		Q1 Q2	20 20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C $I_D = -250 \ \mu$ A, Referenced to 25°C	Q1 Q2		14 -14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16V, V_{GS} = 0 V$ $V_{DS} = -16V, V_{GS} = 0 V$	Q1 Q2			1 –1	μA
I _{GSS}	Gate-Body Leakage		Q1 Q2			±100 ±100	nA
V _{GS(th)}	Gate Threshold Voltage		Q1 Q2	0.6 0.6	1 -0.9	1.5 –1.2	V
<u>∆Vgs(th)</u> 28TJ	Gate Threshold Voltage Temperature Coefficient	$I_D = 250$ uA, Referenced to 25°C $I_D = 250$ uA, Referenced to 25°C	Q1 Q2		-3 3		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$ \begin{array}{l} V_{GS} = 4.5 \; V, I_D = 6.5 \; A \\ V_{GS} = 2.5 \; V, I_D = 5.4 \; A \\ V_{GS} = 4.5 \; V, \; I_D = 6.5 A, \; T_J = 125^\circ C \end{array} $	Q1		25 35 35	30 43 50	mΩ
		$ \begin{array}{l} V_{GS} = -4.5 \ V, \ I_D = -3.2 \ A \\ V_{GS} = -2.5 \ V, \ I_D = -1.0 \ A \\ V_{GS} = -4.5 \ V, I_D = -3.2 \ A, \ T_J = 125^\circ C \end{array} $	Q2		43 64 55	55 90 76	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5V, V_{DS} = 5V$ $V_{GS} = -4.5V, V_{DS} = -5V$	Q1 Q2	15 –16			A
g fs	Forward Transcoductance		Q1 Q2		22 14		S S
Dynamie	c Characteristics						
C _{iss}	Input Capacitance	Q1 $V_{DS} = 10V$, $V_{GS} = 0 V$,	Q1 Q2		650 955		pF
C _{oss}	Output Capacitance	f = 1.0 MHz Q2	Q1 Q2		150 215		pF
C _{rss}	Reverse Transfer Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, $ f = 1.0 MHz	Q1 Q2		85 115		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$	Q1 Q2		1.4 4.9		Ω

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Switchi	ng Characteristics (Note	2)				•	
t _{d(on)}	Turn-On Delay Time	Q1 V _{DD} = 10 V, I _D = 1 A,	Q1 Q2		8 16	16 29	ns
t _r	Turn-On Rise Time	$V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$	Q1 Q2		9 9	17 18	ns
t _{d(off)}	Turn-Off Delay Time	Q2 $V_{DD} = -6V, I_D = -1A,$	Q1 Q2		15 25	26 41	ns
t _f	Turn-Off Fall Time	V_{GS} = -4.5V, R_{GEN} = 6 Ω	Q1 Q2		4 9	9 19	ns
Qg	Total Gate Charge	Q1 V _{DS} = 10 V, I _D = 3 A, V _{GS} = 4.5V	Q1 Q2		6.2 8.7	9 12	nC
Q_{gs}	Gate-Source Charge		Q1 Q2		1.2 2.1		nC
Q_{gd}	Gate-Drain Charge	Q2 $V_{DS} = -6 V, I_D = -3.2 A, V_{GS} = -4.5 V$	Q1 Q2		1.7 2.1		nC
Drain-S	Source Diode Character	istics and Maximum Ratings	5			•	
ls	Maximum Continuous Drain-S	Source Diode Forward Current	Q1 Q2			1.3 -1.3	A
V _{SD}	Drain-Source Diode Forward Voltage		Q1 Q2		0.73 -0.8	1.2 -1.2	V
t _{rr}	Diode Reverse Recovery Time	Q1 I _F = 6.5 A, d _{iF} /d _t = 100 A/µs	Q1 Q2		15 20		nS
Q _{rr}	Diode Reverse Recovery Charge	Q2 I _F = -3.2 A, d _{iF} /d _t = 100 A/µs	Q1 Q2		5 7		nC

Notes:

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 78°C/W when mounted on a 0.5 in² pad of 2 oz copper



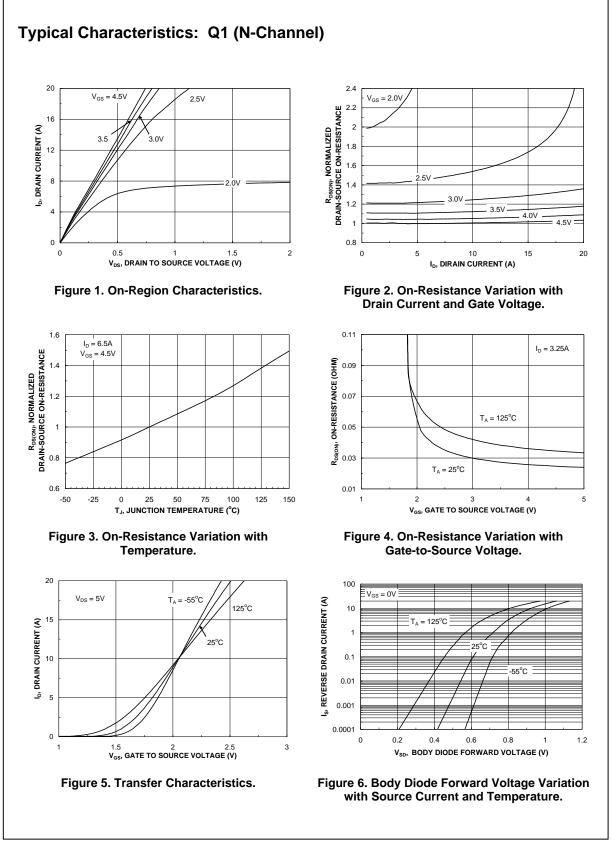
b) 125°C/W when mounted on a .02 in² pad of 2 oz copper

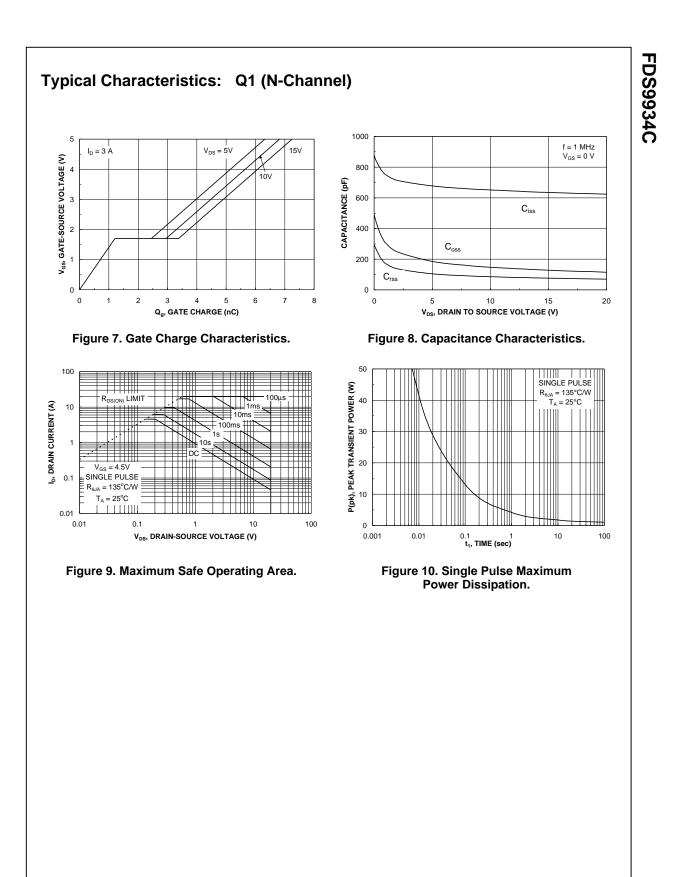
~~~~

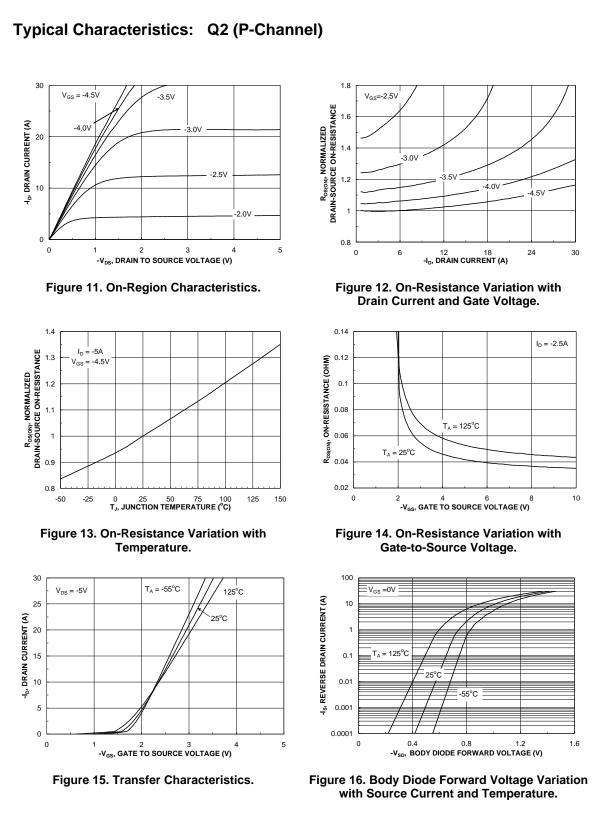
c) 135°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

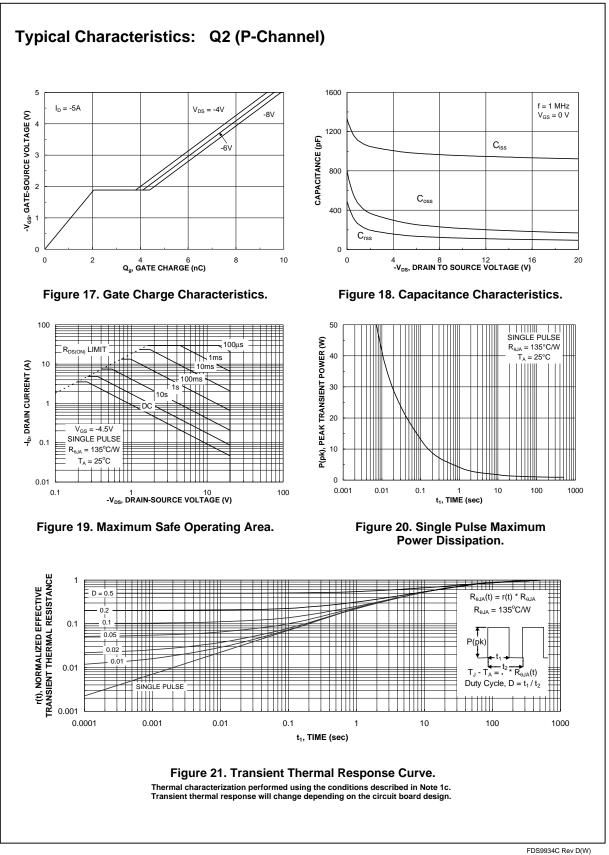






FDS9934C Rev D(W)

FDS9934C



#### TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| ACEx <sup>™</sup><br>ActiveArray <sup>™</sup><br>Bottomless <sup>™</sup><br>Build it Now <sup>™</sup><br>CoolFET <sup>™</sup><br><i>CROSSVOLT</i> <sup>™</sup><br>DOME <sup>™</sup><br>EcoSPARK <sup>™</sup><br>E <sup>2</sup> CMOS <sup>™</sup><br>EnSigna <sup>™</sup><br>FACT <sup>™</sup> | FAST <sup>®</sup><br>FASTr <sup>™</sup><br>FPS <sup>™</sup><br>FRFET <sup>™</sup><br>GlobalOptoisolator <sup>™</sup><br>GTO <sup>™</sup><br>HiSeC <sup>™</sup><br>I <sup>2</sup> C <sup>™</sup><br><i>i</i> -Lo <sup>™</sup><br>ImpliedDisconnect <sup>™</sup> | ISOPLANAR <sup>™</sup><br>LittleFET <sup>™</sup><br>MICROCOUPLER <sup>™</sup><br>MicroFET <sup>™</sup><br>MicroPak <sup>™</sup><br>MICROWIRE <sup>™</sup><br>MSX <sup>™</sup><br>MSXPro <sup>™</sup><br>OCX <sup>™</sup><br>OCX <sup>™</sup><br>OCXPro <sup>™</sup><br>OPTOLOGIC <sup>®</sup> | PowerSaver <sup>™</sup><br>PowerTrench <sup>®</sup><br>QFET <sup>®</sup><br>QS <sup>™</sup><br>QT Optoelectronics <sup>™</sup><br>Quiet Series <sup>™</sup><br>RapidConfigure <sup>™</sup><br>RapidConnect <sup>™</sup><br>µSerDes <sup>™</sup><br>ScalarPump <sup>™</sup><br>SILENT SWITCHER <sup>®</sup> | SuperSOT <sup>™</sup> -6<br>SuperSOT <sup>™</sup> -8<br>SyncFET <sup>™</sup><br>TCM <sup>™</sup><br>TinyLogic <sup>®</sup><br>TINYOPTO <sup>™</sup><br>TruTranslation <sup>™</sup><br>UHC <sup>™</sup><br>UltraFET <sup>®</sup><br>UniFET <sup>™</sup><br>VCX <sup>™</sup> |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FACT Quiet Serie                                                                                                                                                                                                                                                                              | IntelliMAX™                                                                                                                                                                                                                                                    | OPTOLOGIC©<br>OPTOPLANAR™                                                                                                                                                                                                                                                                     | SILENT SWITCHER <sup>©</sup><br>SMART START™                                                                                                                                                                                                                                                               | Wire™                                                                                                                                                                                                                                                                      |
|                                                                                                                                                                                                                                                                                               | I. Around the world.™<br>chise <sup>®</sup>                                                                                                                                                                                                                    | PACMAN™<br>POP™<br>Power247™<br>PowerEdge™                                                                                                                                                                                                                                                    | SPM <sup>™</sup><br>Stealth <sup>™</sup><br>SuperFET <sup>™</sup><br>SuperSOT <sup>™</sup> -3                                                                                                                                                                                                              | WIG                                                                                                                                                                                                                                                                        |

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

| Datasheet Identification | Product Status            | Definition                                                                                                                                                                                                                        |
|--------------------------|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Advance Information      | Formative or<br>In Design | This datasheet contains the design specifications for<br>product development. Specifications may change in<br>any manner without notice.                                                                                          |
| Preliminary              | First Production          | This datasheet contains preliminary data, and<br>supplementary data will be published at a later date.<br>Fairchild Semiconductor reserves the right to make<br>changes at any time without notice in order to improve<br>design. |
| No Identification Needed | Full Production           | This datasheet contains final specifications. Fairchild<br>Semiconductor reserves the right to make changes at<br>any time without notice in order to improve design.                                                             |
| Obsolete                 | Not In Production         | This datasheet contains specifications on a product<br>that has been discontinued by Fairchild semiconductor.<br>The datasheet is printed for reference information only.                                                         |
|                          |                           | Rev. I18                                                                                                                                                                                                                          |